103101007							
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.							
1. Name of conveying party(ies)	2. Name and address of receiving party(ies)						
Yi-Chun LIN Kuo-Ming WU	Name: Taiwan Semiconductor Manufacturing Co., Ltd.						
Ruey-Hsin LIU	Internal Address:						
	2.E						
Additional name(s) of conveying party(ies) attached? Yes ✓ No 3. Nature of conveyance/Execution Date(s):	Street Address: No. 8, Li-Hsin Rd. 6						
Execution Date(s) January 11, 2006	113						
✓ Assignment Merger	Science-Based Industrial Park						
Security Agreement Change of Name	City: Hsin-Chu						
Joint Research Agreement	State:						
Government Interest Assignment	Country: Taiwan, R.O.C. Zip:300-77						
Executive Order 9424, Confirmatory License	Country: Taiwan, R.O.C. Zip: 300-77						
Other	Additional name(s) & address(es) attached? Yes V No						
Additional numbers at	tached?						
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1						
Name:Daniel R. McClure	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00						
Internal Address: Thomas, Kayden, Horstemeyer &	Authorized to be charged by credit card						
Risley, LLP	Authorized to be charged by credit card Authorized to be charged to deposit account						
Street Address: 100 Galleria Parkway	Enclosed						
Suite 1750	None required (government interest not affecting title)						
City: Atlanta	8. Payment Information						
State: Georgia Zip:30339	a. Credit Card Last 4 Numbers 1009 Expiration Date 07/09						
Phone Number: 770-933-9500							
Fax Number: <u>770-951-0933</u>	b. Deposit Account Number Authorized User Name						
Email Address: dan.mcclure@tkhr.com							
9. Signature:	Feb 9, 2006						
Signature	Date						
Daniel R. McClure Name of Person Signing	Total number of pages including cover sheet, attachments, and documents:						

Documents to be recorded (including cover sheet) should be faxed to (703) 306-5995, or mailed to: Mail Stop Assignment Recordation Services, Director of the USPTO, P.O.Box 1450, Alexandria, V.A. 22313-1450 02/14/2006 WASFAW1 00000116 11351254

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ASSIGNMENT

WHEREAS, Yi-Chun LIN, Kuo-Ming WU and Reuy-Hsin LIU hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as desc Kuo-Ming Wu ribed and set forth in the below identified application for United States Letters Patent:

Title:	HIGH	VOLTAGE	SEMICONDUCTOR	DEVICES	AND	METHODS	FOR	FABRICATING	THE
	SAME								
Filed: .				Seri	al No.	· · · · · · · · · · · · · · · · · · ·			
Execute	ed on: _		January 11, 200	06					

WHEREAS, Taiwan Semiconductor Manufacturing Co., Ltd. of No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

TSMC:2004-1323/0503-A31605US

PATENT REEL: 017563 FRAME: 0117

Yi-Chun LIN	11, '06	
Yi-Chun LIN	Date:	
Kuo-Ming Nu	V(1 '06)	

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Reuy-Hsin Liu Date:

TSMC2004-1323/0503-A31605US

RECORDED: 02/09/2006

PATENT REEL: 017563 FRAME: 0118